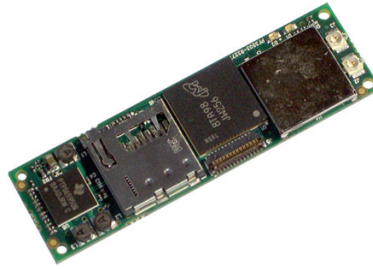


Overo FE Technical Specifications



CPU	
Processor	Texas Instruments OMAP3530
Architecture	ARM Cortex-A8
Base Clock Speed	600 MHz
Max Clock Speed	720 MHz
Cores	Single Core
Memory	
RAM	512 MB LPDDR (PoP)
Flash	512 MB
Graphics	
HD Graphics Acceleration	PowerVR SGX530
Open GL ES	2.0
Clock Speed	200 MHz
Digital Signal Processor	C64x+
Communications	
Wireless Module	Wi2Wi W2CBW003
WiFi	802.11b/g
Access Point Mode	N/A
Bluetooth	2.0+EDR
Antenna	2 x u.fl Connector
Connectivity	
Camera	OMAP ISP
Storage Expansion	microSD Card Slot
Breakout: 2 x 70 Pin AVX	
UART	2
McBSP	
SPI	2
I²C	1
MMC	1
HDMI	
LCD	24-Wire
Touchscreen	Supported
USB	1 x Host / 1 x OTG
GPIO	3 to 6 Pins ¹
PWM	2
ADC	6 x 10-Bit
Audio	Stereo Out / Stereo Line In
GPMC	1 ²

Power	
Power Management	Texas Instruments TPS65950
Power Input	3.3 - 4.2 V DC
Physical Specifications	
Dimensions	58mm L x 17mm W x 4.2mm H
Weight	5.6 g
Operating Temperature	-40°C – 85°C ³
RoHS Compliant	Yes

1. Depending on expansion board and based on default muxings. Available GPIOs can be modified via kernel configuration.
2. GPMC availability depends on expansion board features.
3. Industrial Temperature Rating, Except:
 - microSD card slot: -25°C – 85°C
 - WiFi/Bluetooth module: -20°C – 70°C
 - PoP memory: -25°C – 85°C

